



YOUSHANG SEMICONDUCTOR

**设计研发新型功率器件**

**各类小信号开关**

**中低压及高压大电流等场效应管**

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## Features

- $BV_{CEO} > -60V$
- $I_C = -5.5A$  Continuous Collector Current
- $I_{CM} = -15A$  Peak Pulse Current
- Low Saturation Voltage  $V_{CE(SAT)} < -70mV$  Max @  $-1A$
- $R_{SAT} = 39m\Omega$  @  $-5A$  for Low Equivalent On-Resistance
- $h_{FE}$  Specified up to  $-10A$  for High Gain Hold Up

## Mechanical Data

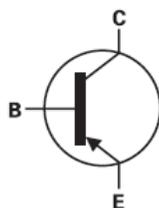
- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 
- Weight: 0.112 grams (Approximate)

## Applications

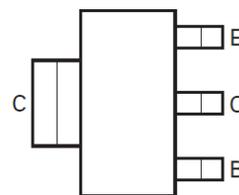
- DC-DC Converters
- MOSFET Gate Drivers
- Charging Circuits
- Power Switches
- Motor Control



Top View



Device Schematic



Pin-Out Top View

### Absolute Maximum Ratings

 (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CB0}$	-100	V
Collector-Emitter Voltage	$V_{CEO}$	-60	V
Emitter-Base Voltage	$V_{EBO}$	-7	V
Continuous Collector Current	$I_C$	-5.5	A
Peak Pulse Current	$I_{CM}$	-15	A

### Thermal Characteristics

 (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation	$P_D$	3.0	W
		24	
Linear Derating Factor		1.6	mW/ $^\circ\text{C}$
		12.8	
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	42	$^\circ\text{C}/\text{W}$
	$R_{\theta JA}$	78	
Thermal Resistance, Junction to Lead	$R_{\theta JL}$	8.8	
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

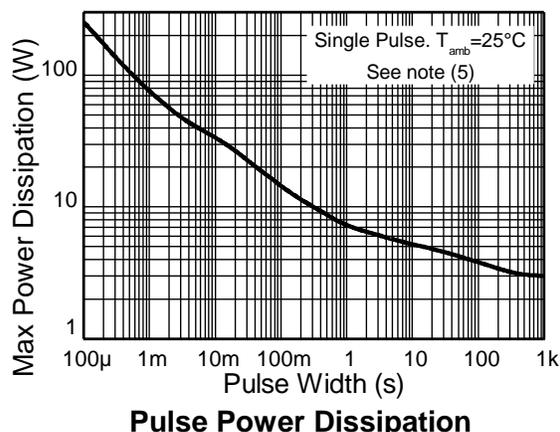
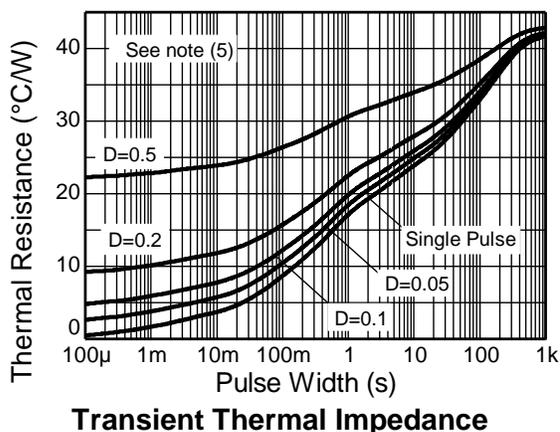
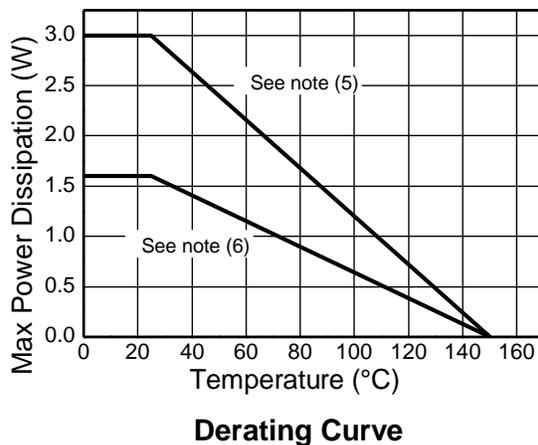
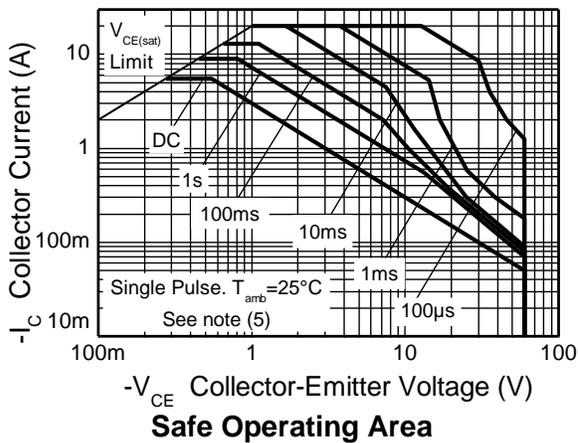
### ESD Ratings

 (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
5. For a device mounted with the collector lead on 52mm x 52mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  6. Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
  7. Thermal resistance from junction to solder-point (at the end of the collector lead).
  8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

**Thermal Characteristics and Derating Information**

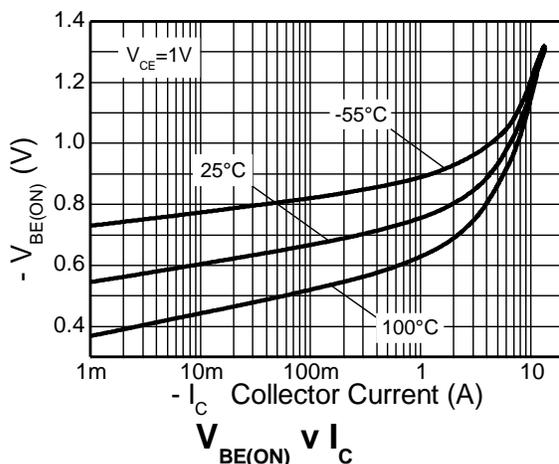
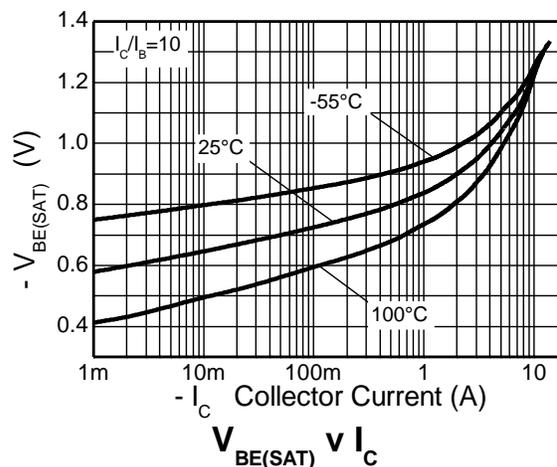
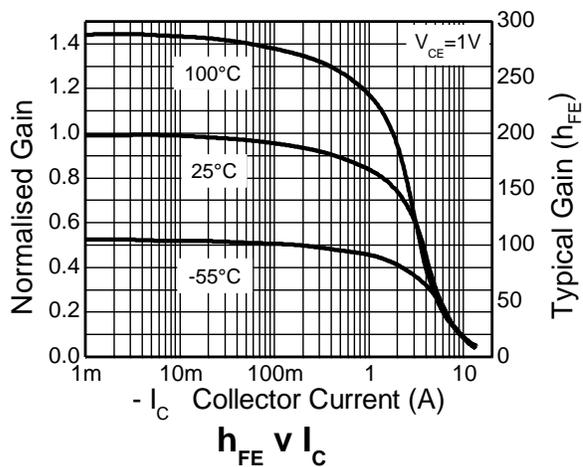
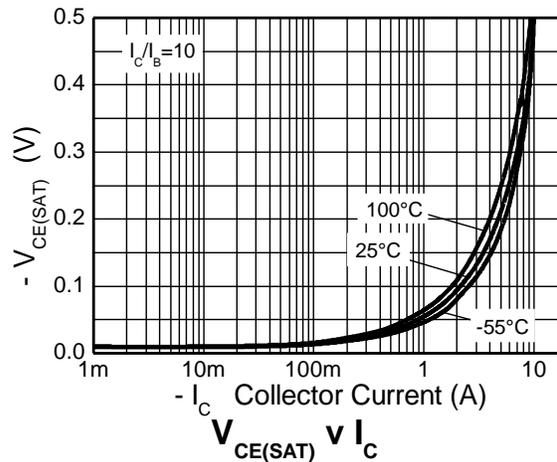
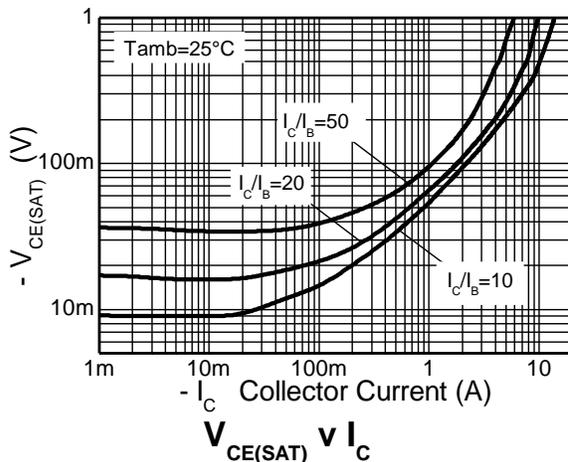


**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$BV_{CBO}$	-100	-120	—	V	$I_C = -100\mu\text{A}$
Collector-Emitter Breakdown Voltage	$BV_{CER}$	-100	-120	—	V	$I_C = -1\mu\text{A}$ , $R_B \leq 1\text{k}\Omega$
Collector-Emitter Breakdown Voltage (Note 9)	$BV_{CEO}$	-60	-80	—	V	$I_C = -10\text{mA}$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	-7	-8.1	—	V	$I_E = -100\mu\text{A}$
Collector Cutoff Current	$I_{CBO}$	—	< -1	-20	nA	$V_{CB} = -80\text{V}$
		—	—	-0.5	$\mu\text{A}$	$V_{CB} = -80\text{V}$ , $T_A = +100^\circ\text{C}$
Collector Cutoff Current	$I_{CER}$ $R_{\leq 1\text{k}\Omega}$	—	< -1	-20	nA	$V_{CB} = -80\text{V}$
		—	—	-0.5	$\mu\text{A}$	$V_{CB} = -80\text{V}$ , $T_A = +100^\circ\text{C}$
Emitter Cutoff Current	$I_{EBO}$	—	< -1	-10	nA	$V_{EB} = -6\text{V}$
Collector-Emitter Saturation Voltage (Note 9)	$V_{CE(SAT)}$	—	-15 -55 -90 -195	-25 -70 -120 -250	mV	$I_C = -0.1\text{A}$ , $I_B = -10\text{mA}$ $I_C = -1\text{A}$ , $I_B = -100\text{mA}$ $I_C = -2\text{A}$ , $I_B = -200\text{mA}$ $I_C = -5\text{A}$ , $I_B = -500\text{mA}$
Base-Emitter Saturation Voltage (Note 9)	$V_{BE(SAT)}$	—	-1.03	-1.15	V	$I_C = -5\text{A}$ , $I_B = -500\text{mA}$
Base-Emitter Turn-On Voltage (Note 9)	$V_{BE(ON)}$	—	-0.92	-1.02	V	$I_C = -5\text{A}$ , $V_{CE} = -1\text{V}$
DC Current Gain (Note 9)	$h_{FE}$	100 100 45 10	250 200 90 25	300	—	$I_C = -10\text{mA}$ , $V_{CE} = -1\text{V}$ $I_C = -2\text{A}$ , $V_{CE} = -1\text{V}$ $I_C = -5\text{A}$ , $V_{CE} = -1\text{V}$ $I_C = -10\text{A}$ , $V_{CE} = -1\text{V}$
Transition Frequency	$f_T$	—	120	—	MHz	$V_{CE} = -10\text{V}$ , $I_C = -100\text{mA}$ , $f = 50\text{MHz}$
Output Capacitance (Note 9)	$C_{OBO}$	—	48	—	pF	$V_{CB} = -10\text{V}$ , $f = 1\text{MHz}$
Switching Times	$t_{ON}$	—	39	—	ns	$V_{CC} = -10\text{V}$ , $I_C = -1\text{A}$ , $I_{B1} = -I_{B2} = 100\text{mA}$
	$t_{OFF}$	—	370	—		

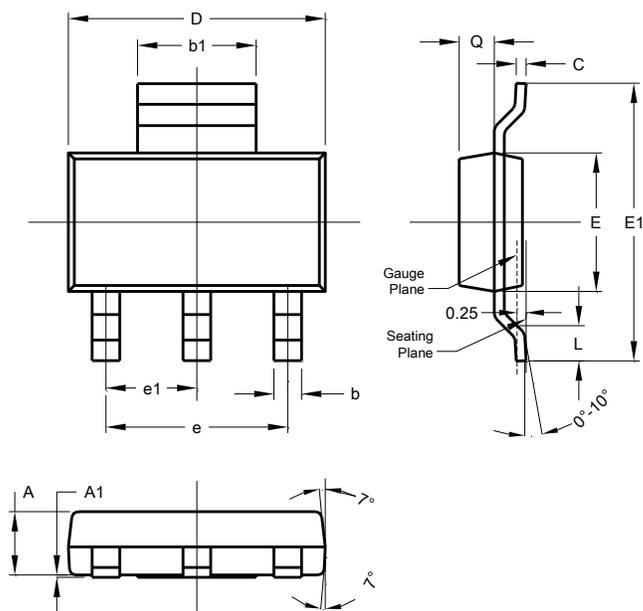
 Note: 9. Measured under pulsed conditions. Pulse width  $\leq 300\mu\text{s}$ . Duty cycle  $\leq 2\%$ .

**Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



## Package Outline Dimensions

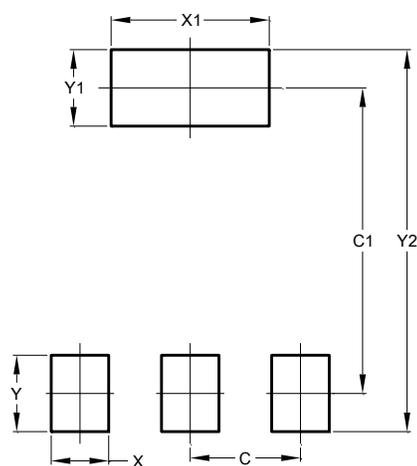
SOT223



SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b	0.60	0.80	0.70
b1	2.90	3.10	3.00
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	-	-	4.60
e1	-	-	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

## Suggested Pad Layout

SOT223



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
C2	8.00